



SPECIFICATION

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SPEC. NO.: PS-50271-XXXXX-XXX

REVISION: F

PRODUCT NAME: 1.25mm Pitch Wire to Board Connector

PRODUCT NO: 50271 Series. 50272 Series. 51454 Series.

PREPARED: LUTAOTAO DATE: 2019.06.18	CHECKED: BRAVE DATE: 2019.06.18	APPROVED: FRANK DATE: 2019.06.18
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Aces P/N: **50271series, 50272 series, 51454series**

TITLE: 1.25MM PITCH WIRE TO BOARD CONNECTOR

RELEASE DATE: **2019/06/19**

REVISION: **F**

ECN No: **ECN-1906345**

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1 Revision History

Rev.	ECN #	Revision Description	Prepared	Date
O	ECN-0812248	NEW SPEC	Jason	2008.11.22
A	ECN-0909015	增加手焊溫度定義	Jason	2009.09.02
B	ECN-1005167	REVISE SPEC	Violet	2010/05/05
C	ECN-1401172	ADD WORKING VOLTAGE	Xufei	2014.01.09
D	ECN-1504307	REVISE SPEC	Zhuwei	2015.04.21
E	ECN-1508293	REVISE SPEC	Zhuwei	2015.08.21
F	ECN-1906345	ADD 51454 Series.	LuTaoTao	2019.06.18

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2 SCOPE

This specification covers requirements for 1.25mm Wire to board LPF connector, which consists of Pin header mated with the crimped contacts assembled in the housing, unless otherwise specified. This product spec. Refer to Aces' P/N: **50271 Series; 50272 Series; 51454 Series;**

3 APPLICABLE DOCUMENTS

EIA-364 ELECTRONICS INDUSTRIES ASSOCIATION

4 REQUIREMENTS

4.1 Design and Construction

Product shall be of design, construction and physical dimensions specified on applicable product drawing.

4.2 Materials and Finish

4.2.1 Contact: High performance copper alloy

Finish: Pls see P/N LEGEND.

4.2.2 Housing: Thermoplastic or Thermoplastic High Temp., UL94V-0

4.2.3 Fitting Nail: Copper Alloy,.

4.3 Ratings

4.3.1 Working voltage less than 36 volts (per pin)

4.3.2 Voltage: 125 Volts AC

4.3.3 Current: AWG#28: 1.0A, AWG#30:1.0A, AWG#32:0.8 Amperes (per pin)

4.3.4 Operating Temperature : -40°C to +85°C

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5 Performance

5.1. Test Requirements and Procedures Summary

Item	Requirement	Standard
Examination of Product	Product shall meet requirements of applicable product drawing and specification.	Visual, dimensional and functional per applicable quality inspection plan.
ELECTRICAL		
Item	Requirement	Standard
Low Level Contact Resistance	55 m Ω Max.(initial)per contact 20 m Ω Max. Change allowed	Mate connectors, measure by dry circuit, 20mV Max., 100mA Max. (EIA-364-23)
Insulation Resistance	100 M Ω Min.	Unmated connectors, apply 500 V DC between adjacent terminals. (EIA-364-21)
Dielectric Withstanding Voltage	No discharge, flashover or breakdown. Current leakage: 1 mA max.	500 VAC Min. at sea level for 1 minute. Test between adjacent contacts of unmated connectors. (EIA-364-20)
Temperature rise	30°C Max. Change allowed	Mate connector: measure the temperature rise at rated current until temperature stable. The ambient condition is still air at 25°C (EIA-364-70 METHOD 1, CONDITION 1)
MECHANICAL		
Item	Requirement	Standard
Durability	50 cycles.	The sample should be mounted in the tester and fully mated and unmated the number of cycles specified at the rate of 25.4 \pm 3mm/min. (EIA-364-09)
Mating / Un-mating Force	Refer to item 8 Mating and un-mating force	Operation speed : 25.4 \pm 3 mm/minute. Measure the force required to mate/Un-mate connector. (EIA-364-13)
Contact Retention Force	0.5Kgf [4.9N] Min.	Operation Speed : 25.4 \pm 3 mm/minute. Measure the contact retention force with Tensile strength tester.

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Crimping Pull Out Force	AWG# 28: 1.0Kgf [9.8N] Min. AWG# 30: 0.5Kgf [4.9N] Min. AWG# 32: 0.3Kgf [2.9N] Min.	Operation Speed : 25.4 ± 3 mm/minute. Fix the crimped terminal, apply axial pull out force on the wire.
Terminal Insertion Force	0.5Kgf [4.9N] Max.	Insert the crimped terminal into the housing, speed rate of 25.4 ± 3 mm/minute.
Terminal / Housing Retention Force	0.3kgf [2.94N] MIN.	Apply axial pull out force at the speed rate of 25.4 ± 3 mm/minute. On the terminal assembled in the housing.
Fitting Nail /Housing Retention Force	0.1kgf [0.98N] MIN.	Apply axial pull out force at the speed rate of 25.4 ± 3 mm/minute. On the fitting nail assembled in the housing.
Vibration	1 μs Max.	The electrical load condition shall be 100 mA maximum for all contacts. Subject to a simple harmonic motion having amplitude of 0.76mm (1.52mm maximum total excursion) in frequency between the limits of 10 and 55 Hz. The entire frequency range, from 10 to 55 Hz and return to 10 Hz, shall be traversed in approximately 1 minute. This motion shall be applied for 2 hours in each of three mutually perpendicular directions. (EIA-364-28 Condition I)
Shock (Mechanical)	1 μs Max.	Subject mated connectors to 50 G's (peak value) half-sine shock pulses of 11 milliseconds duration. Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks). The electrical load condition shall be 100mA maximum for all contacts. (EIA-364-27, test condition A)

ENVIRONMENTAL

Item	Requirement	Standard
Resistance to Hand Soldering Heat	See Product Qualification and Test Sequence Group 9	Soldering iron : 350°C±10°C Duration:3~4sec Max.
Resistance to Reflow Soldering Heat	See Product Qualification and Test Sequence Group 10 (Lead Free)	Pre Heat : 150°C~180°C, 60~120sec. Heat : 230°C Min., 40sec Min. Peak Temp. : 260°C Max, 10sec Max.

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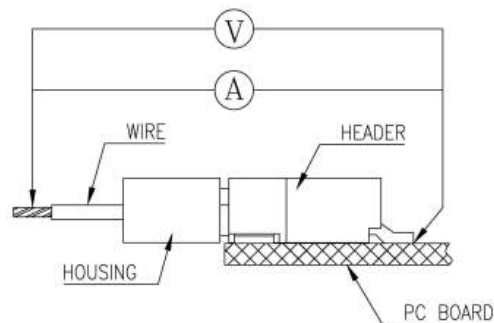
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Thermal Shock	See Product Qualification and Test Sequence Group 4	Mate module and subject to follow condition for 5 cycles. 1 cycles: -40 +0/-3 °C, 30 minutes +85 +3/-0 °C, 30 minutes (EIA-364-32, test condition A)
Humidity	See Product Qualification and Test Sequence Group 4	Mated Connector 40°C, 90~95% RH, 96 hours. (EIA-364-31, Condition A, Method II)
Temperature life	See Product Qualification and Test Sequence Group 5	Subject mated connectors to temperature life at 85°C for 96 hours. Measure Signal. (EIA-364-17, Test condition A)
Salt Spray	See Product Qualification and Test Sequence Group 6	Subject mated/unmated connectors to 5% salt-solution concentration, 35°C (a) Bright Tin & Matt Tin for 24hrs. (b) Gold Flash for 8 hrs. (c) Gold (3u") for 12 hrs. (d) Gold (5u" or over) for 96 hrs. (EIA-364-26)
Solder ability	Solder able area shall have minimum of 95% solder coverage.	Subject the test area of contacts into the flux for 5-10 sec. And then into solder bath, Temperature at 245 ±5°C, for 4-5 sec. (EIA-364-52)

Note. Flowing Mixed Gas shall be conducted by customer request.



Contact Resistance Measurement

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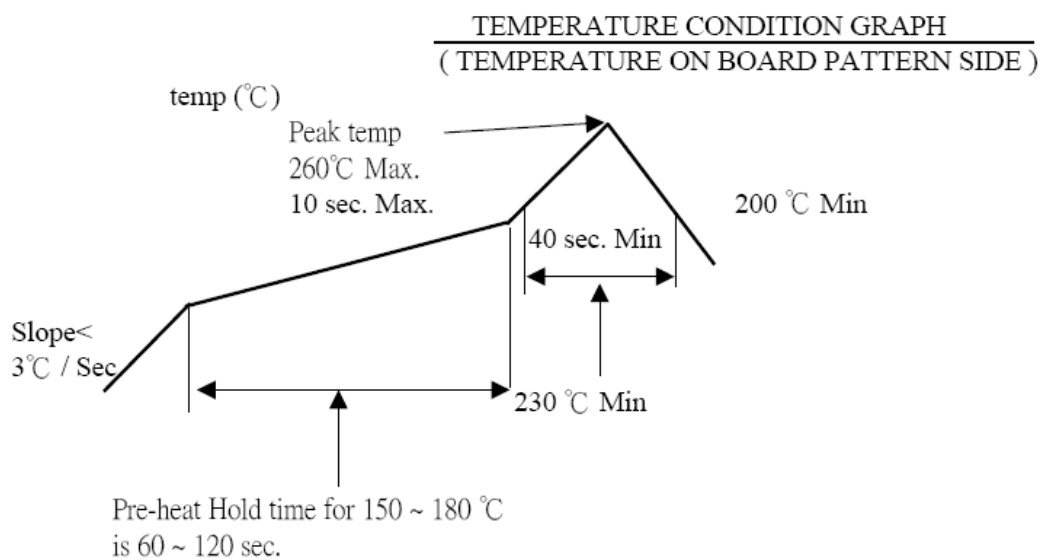
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6 INFRARED REFLOW CONDITION

6.1. Lead-free Process



(2 cycles max.)

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7 PRODUCT QUALIFICATION AND TEST SEQUENCE

Test or Examination	Test Group										
	1	2	3	4	5	6	7	8	9	10	11
	Test Sequence										
Examination of Product	1、3	1、7	1、6	1、7	1、6	1、4				1	
Low Level Contact Resistance		2、6	2、5	2、10	2、9	2、5				3	
Insulation Resistance				3、9	3、8						
Dielectric Withstanding Voltage				4、8	4、7						
Temperature rise	2										
Mating / Un-mating Forces		3、5									
Durability		4									
Contact Retention Force								1			
Vibration			3								
Shock (Mechanical)			4								
Thermal Shock				5							
Humidity				6							
Temperature life					5						
Salt Spray						3					
Solder ability							1				
Terminal Insertion Force									1		
Terminal / Housing Retention Force									2		
Fitting Nail /Housing Retention Force									3		
Resistance to Soldering Heat										2	
Crimping Pull Out Force											1
Sample Size	2	4	4	4	4	4	2	4	4	4	4

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8 MATING AND UNMATING FORCE

No of CKT	Insertion Force (Kgf, Max)			Extraction Force (Kgf, Min)		
	1st	6th	50th	1st	6th	50th
2	2.00	1.80	1.60	0.28	0.23	0.18
3	2.50	2.30	2.10	0.30	0.25	0.20
4	3.00	2.80	2.60	0.33	0.28	0.23
5	3.50	3.30	3.10	0.38	0.33	0.28
6	4.00	3.80	3.60	0.43	0.38	0.33
7	4.50	4.30	4.10	0.48	0.43	0.38
8	5.00	4.80	4.60	0.53	0.48	0.43
9	5.50	5.30	5.10	0.56	0.51	0.46
10	6.00	5.80	5.60	0.59	0.54	0.49
11	6.50	6.30	6.10	0.62	0.57	0.52
12	7.00	6.80	6.60	0.65	0.60	0.55
13	7.50	7.30	7.10	0.68	0.63	0.58
14	8.00	7.80	7.60	0.71	0.66	0.61
15	8.50	8.30	8.10	0.74	0.69	0.64